



The product described in this document has not been fully tested to ensure conformance to the requirements outlined below. Therefore, TE Connectivity (TE) makes no representation or warranty, express or implied, that the product will comply with these requirements. Further, TE may change these requirements based on the results of additional testing and evaluation. Contact TE Engineering for further details.

**SMC – Receptacle with Ribbon Cable – IDC & Header**

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## 1. SCOPE

### 1.1. Content

This specification describes the requirements, performance and testing for the double row Insulation Displacement Connector (IDC) system SMC.

The platform is intended for use with flat ribbon cables and has pin counts from 12 to 80 positions.

SMC Female connector with cable outlet 90° in combination with Male connector PCB orientation straight or right-angled.



### 1.2. General Product Description

This double row Insulation Displacement Connector (IDC) contact system combines the features of high packing density, robust construction and highest functional requirements. Despite its miniaturized design with a grid of 1,27mm, it fulfills all requirements for a contact system suitable for use in an industrial environment and as well in automobiles on a high-performance level.

The electrical contact is made by a rectangle pin with dimension of 0.3mm x 0.42mm. The IDC socket contact has two contact points for electrical connection. The contact normal force is generated by a dual beam contact system.

The IDC contact is inseparably attached to the female housing. The IDC supports a AWG30 flat ribbon cable sizes exclusively.

A primary and secondary locking device (TPA) is not needed for IDC connection.

A Connector Position Assurance (CPA) is not available.

The connector system is unsealed.

### 1.3. Qualification

When tests are performed for the System, procedures specified in Chapter **Fehler! Verweisquelle konnte nicht gefunden werden.** shall be used.

All tests must be carried out according to the associated inspection plans and drawings.

### 1.4. Qualification Test Results

The product performs the electrical, mechanical and climatic requirements of Chapter 3.5

## 2. APPLICABLE DOCUMENTS AND FORMS

The following documents constitute a part of this specification to the extent specified herein. Unless otherwise indicated, the latest edition of the document is applicable.

### 2.1. TE Documents

- 114-160992: Application Specification (SMC IDC Socket Housing)
- 114-TBD: Application Specification (SMC SMT Male Housing)
- 107-TBD: Product Packaging Specification
- 501- .....: Qualification Test Report

	Industrial + MIL	Industrial UL	Automotive	Automotive
Specification	IEC60603* EN 60352-2**	UL 1977 (USR) UL/CSA	USCAR2 USCAR21	LV214
Test Report No	501-917e_IND* 501-918e_IND**	File E84703	-	501-3001_AE 501-3002_AE 501-3003_AE

\* Connector Qualification

\*\* Ribbon Cable Qualification

### 2.2. Industry Documents and Standards

- DIN/IEC 60512 Electromechanical components for electrical equipment, basic testing procedures and measuring methods
- DIN EN 60068 Environmental testing
- EN 60352-4 Solderless connections – solderless non-accessible insulation displacement connections; General requirements
- IEC 60603-2 Connectors for frequencies below 3MHz for use with printed boards
- MIL-STD-1344A Military Standard – Test for Electrical Connectors
- UL1977 Component Connectors for Use in Data, Signal, Control and Power Applications (Rev 3: 2007-12)
- LV214 Motor Vehicle Connectors (VW75174:2018-10; VW75174:2010-04)
- IPC/JEDEC J-STD-020 Moisture/Reflow Sensitivity Classification for Non-hermetic Solid State Surface Mount Devices

### 2.3. Reference Document

- 109-197 Test Specification (TE Test Specification vs EIA and IEC Test Methods)

### 3. REQUIREMENTS

#### 3.1. Design and Construction

Product shall be of the design, construction, materials and physical dimensions specified on the applicable product drawing.

The product has the following ratings (operating):

	Industrial + MIL	Industrial UL	Automotive	Automotive
Specification	IEC60603	UL 1977** (USR)	USCAR2 USCAR21	LV214
Temperature Class - Au	-40°C to 125°C	(130°C)**	-	-40°C to 125°C
Vibration Class - Sinusoidal - Random - Shock	Performance Category 1 10-2000Hz/ 7,5h/ 20g 30-1050Hz/ 20h/ 3,5g; 1,2g 10 shocks @ 50g/ 11ms	-	-	PG17 S2
Sealing Class IP Class (IEC 60529)	IP00		-	Unsealed
Operating Voltage (U <sub>RMS</sub> )	10VDC*			
Durability Mating Cycles - Au	Performance Category 1 500 cycles	-	-	100 cycles
Current Carrying Capability (AWG30)	-	-	-	1,23A (20-pole) 0,98A (40-pole) 0,91A (80-pole)
Wire Size	0,13mm <sup>2</sup> AWG26			
IDC Qualification	DIN EN 60352-4	-	-	LV214*** DIN EN 60352-4
Flammability (Connector HSG Components)	UL94 V0			

\* Voltage Rating is in accordance with IEC 60 664-1 (DIN VDE 0110) – corresponding to C&C, CTI and Pollution Degree 2

\*\* Base Material Temperature Rating for Molding Materials (Male/Female)

\*\*\* Applicable and Relevant Test Groups

### 3.2. Materials

Description	Material	Color * with Mechanical Coding	Characteristics
Female housing	LCP reinforced	black	CTI = 175
Cable guide	LCP reinforced	black	CTI = 175
Female IDC contact	Copper Alloy		
Plating connection area	Sn over Ni		
Plating contact area	Au finish		
Male housing (angled)	LCP reinforced	black	CTI = 175
Male contact (angled)	Copper Alloy		
Plating connection area	Sn over Ni		
Plating contact area	Au finish		
Male housing (straight)	LCP reinforced	black	CTI = 175
Male contact (straight)	Copper Alloy		
Plating connection area	Sn over Ni		
Plating contact area	Au finish		

### 3.3. Ratings


Pin count	Voltage Rating (U <sub>RMS</sub> )	Maximum Current <sup>2</sup> (AWG30)	Ambient Temperature <sup>3</sup> for operation	Maximum Operating temperature <sup>4</sup>
12-80	10 VDC <sup>1</sup>	1.6 at 20 °C 0.9 at 90 °C 0.5 A at 110°C 0.0 A at 125°C	-40 °C to 125 °C  Additional restrictions may result from the applied wire.	125 °C with 0 A  Additional restrictions may result from the applied wire.

<sup>1</sup> Voltage Rating is in accordance with IEC 60 664-1 (DIN VDE 0110) – corresponding to C&C, CTI and Pollution Degree 2.

<sup>2</sup> Maximum current for 12-pin connector (type Q male header 90° & type B female receptacle 90°) on Standard one-layer FR4 PCB. For other number of poles the number of poles specific derating curve must be applied.

<sup>3</sup> Environmental temperatures wherein the assembly is allowed to operate in.

<sup>4</sup> Maximum operating temperature - including temperature rise of the contacts by applying an electrical current.

<b>Applicable Wire</b>  Flat Ribbon Cable	AWG 30/7Sn (7x0,102 / 0,06mm <sup>2</sup> ) AWG 30/7Ag (7x0,102 / 0,06mm <sup>2</sup> )  
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### 3.4. Quality Assurance Provision

#### 3.4.1. Operation Mode

- Pollution degrees 2 addition: restricted to a non-condensing environment. (IEC 61010-1)
- Overvoltage category 2 (IEC 60664-1)
- Maximum operating altitude 2000 m (IEC 60664-1)
- Condensation: Not permitted
- Icing: Not permitted
- Precipitation, rainfall: Not permitted
- Water (except rainfall): Not permitted
- Moisture: Permitted

#### 3.4.2. IP Protection Class

- IP00 Female housing type P cable outlet 90°

#### 3.4.3. Storage Condition

- According to IEC 60721-3-1 Class 1K4

#### 3.4.4. Technical Cleanliness

- VDA Band 19 / ISO 16232, max. metallic flitter size: 400µm

#### 3.4.5. Soldering and MSL

- IPC/JEDEC J-STD-020
- MSL 1

#### 3.4.6. Test Condition

Unless otherwise specified, all tests shall be performed at ambient environmental conditions.

Temperature	15 – 35 °C
Relative humidity	25 - 75%
Atmospheric pressure	86 – 106 kPa

### 3.5. Test Requirements and Procedures Summary

Unless otherwise specified, all tests shall be performed at ambient environmental conditions.

#### Test Coverage:

IEC 60603-2 Connectors for frequencies below 3MHz for use with printed boards - performance level 1

MIL-STD-1344A Military Standard – Test for Electrical Connectors

LV214 Motor vehicles connectors - according to the qualification matrix LV214-1.

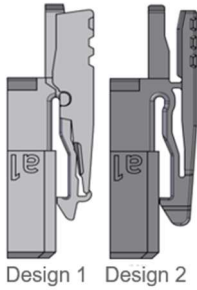
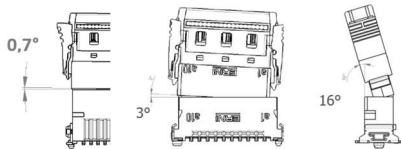
TEST DESCRIPTION	REQUIREMENT	PROCEDURE
	<b>VISUAL / GENERAL</b>	
<b>LV214 TG0 / TG1</b> Initial examination of product / Visual inspection Dimensions	Meets requirements of product drawing (drawing conformity)	VW75174:2018-10 E0.1 / DIN EN 60512-1-1 E1.1 / DIN EN 60512-1-2
<b>LV214 TG1</b> Dimension of processed components  <b>DIN EN 60352-4</b> Solderless connections - IDC	Meets requirements of product drawing (drawing conformity)	VW75174:2018-10 E1.2 / DIN EN 60512-1-2  DIN EN 60352-2 ZP1

	<b>ELECTRICAL</b>	
<b>LV214 – TG0</b> <b>Inspection of as-received condition</b> Volume resistance Insulation resistance	$R < 50\text{m}\Omega$ (AWG30) $R_{\text{ins}} > 100\text{M}\Omega$ at $U=500\text{V}$ , $t=60\text{s}$	VW75174:2018-10 P 0.2 / DIN EN 60512-2-1 P 0.3 / DIN EN 60512-3-1
<b>DIN EN 60603-2 – P3</b> <b>Contact resistance</b>	$R \leq 25\text{m}\Omega$	DIN EN 60512-2-1 MIL STD-1344 A 3002.1
<b>DIN EN 60603-2 – P4</b> <b>Insulation resistance</b>	$R \geq 10^{10} \Omega$	DIN EN 60512-3-1 MIL STD-1344 A 3003.1
<b>DIN EN 60603-2 – P5</b> <b>Voltage proof</b>	$U_{\text{test}} = 500V_{\text{eff}}$ (contact/contact)	DIN EN 60512-4-1 MIL STD-1344 A 3001.1
<b>LV214 – TG12</b> <b>Current heating, derating</b> Derating without contact housing	Documentation and Determination Nominal current $I_{\text{nom}}$  $I_{\text{nominal}} = 1,23\text{A}$ (20-pole) $I_{\text{nominal}} = 0,98\text{A}$ (40-pole) $I_{\text{nominal}} = 0,91\text{A}$ (80-pole)	VW75174:2018-10 P 12.2 n.a. Contact parts are inseparably attached to the housing. It is not possible to assemble the wire without a housing.  For nominal current ( $I_{\text{nom}}/I_{\text{test}}$ ) a current $I$ [A] from TG13 derating curve at 80°C ambient temperature is used.
<b>LV214 – TG13</b> <b>Influence of the contact housing on the derating</b> Derating with contact housing	See Chapter 4.1 Derating - Number of Poles Specific	VW75174:2018-10 P13.2
<b>LV214 – TG14</b> <b>Thermal time constant (current overtemperature at n times the nominal current)</b> Thermal time constant	See Chapter 4.3 Thermal Time Constant – LV214 TG14	VW75174:2018-10 P 14.1 The nominal current $I_{\text{nom}}$ is picked from TG13 (at 80°C ambient temperature) $I_{\text{nominal}} = 1,23\text{A}$ (20-pole) $I_{\text{nominal}} = 0,98\text{A}$ (40-pole) $I_{\text{nominal}} = 0,91\text{A}$ (80-pole) Wire Size: AWG30 $T_{\text{max.}}: 125^{\circ}\text{C}$
P 0.1 Visual inspection	No defects were detected. No changes on the contact surfaces were detected.	

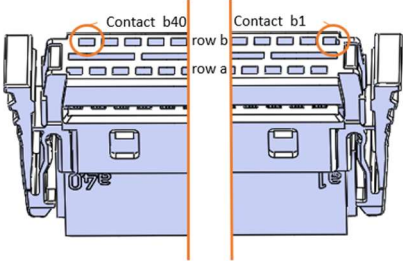


<b>DIN EN 60603-2 – Test Batch DP</b>		
Gauge retention force	$F_{\text{contact retention}} \geq 0,1\text{N}$ (per contact)	DP0 / DIN EN 60512-16-5
Mechanical operation	Carry out	DP1 / DIN EN 60512-9-1 MIL STD-1344 A 2016 $V = \leq 10\text{mm/s}$ Rest period: $\leq 30\text{s}$ (not inserted) No of cycles: 250
Electrical load and temperature		DP2 / DIN EN 60512-9-2 MIL STD-1344 A 1005 $T = 125^{\circ}\text{C}$ $I = [\text{A}]$ not applied $t = 1000\text{h}$
Contact resistance	$R \leq 25\text{m}\Omega$	DP3 / DIN EN 60512-2-1 MIL STD-1344 A 3002.1
Gauge retention force	$F_{\text{contact retention}} \geq 0,1\text{N}$ (per contact)	DP0.1 / DIN EN 60512-16-5
Voltage proof	$U_{\text{test}} = 500V_{\text{eff}}$ (contact/contact)	DP4 / DIN EN 60512-4-1 MIL STD-1344 A 3001.1
Visual examination	No faults	DP8 / DIN EN 60512-1-1

<b>MECHANICAL</b>		
<b>LV214 – TG4</b>		
<b>Contact overlap</b>		VW75174:2018-10
Contact overlap	Contact overlap 2.24mm Clearance 0.78mm	P 4.1 CAD determined
<b>LV214 – TG6</b>		
<b>Interaction between contact and contact housing</b>		VW75174:2018-10
Function of the primary locking device/latch play	n.a., contact parts are inseparably pre-assembled in the housing (state of delivery)	P 6.2
Function of the secondary locking device/latch play		P 6.3
Actuation forces for the secondary locking device	n.a. IDC connector has no secondary locking	P 6.4
Drop test	while drop test the pre-latched parts remain in pre-latched position - transport of unequipped contact housings assembled parts stay assembled - transport of equipped contact housings	L 6.1

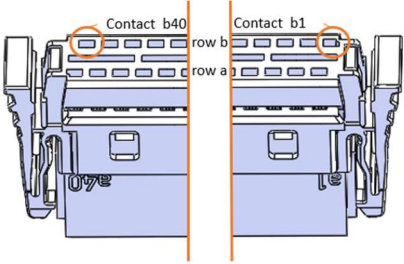
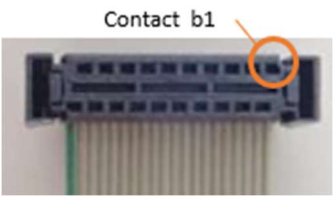
<p><b>LV214 – TG7</b></p> <p><b>Handling and functional reliability of the contact housings</b></p> <p>Distinctiveness of the unequipped contact housings (keying/polarization)</p> <p>Holding force of the contact housing latching/locking</p> <p>CPA function check</p> <p>Insertion force or actuation force for insertion and extraction aids</p>	<p><math>F_{\text{keying}} \geq 50 \text{ N}</math> (0,5mm blade size)</p> <p><math>F_{\text{holding}} &gt; 60 \text{ N}</math> (12 to 80-pin) Design 2  <math>F_{\text{holding}} &gt; 20 \text{ N}</math> (12 to 80-pin) Design 1</p>  <p>Design 1 Design 2</p> <p>n.a. The connector system has no CPA feature</p> <p><math>F_{\text{insertion}} &lt; 75 \text{ N}</math>          (typical &lt;30N for 80-pole Design 2)</p>	<p>VW75174:2018-10</p> <p>P 7.1 / DIN EN 60512-13-5</p> <p>P 7.2 / DIN EN 60512-15-6</p> <p>P 7.3</p> <p>P 7.4</p>
<p><b>LV214 – TG8</b></p> <p><b>Insertion and holding forces of the contact parts in the contact housing</b></p>	<p>n.a., contact parts are inseparably pre-assembled in the housing (state of delivery)</p>	<p>VW75174:2018-10</p>
<p><b>LV214 – TG9</b></p> <p><b>Pin insertion angle / misuse-proofing (scoop-proofing)</b></p> <p>Scoop proof testing of contact housing</p>	<p>SMC IDC do not meet the requirement for scoop-proofing.</p> <p>Maximum allowed mating angle:</p>  <p>80-pole &amp; 20-pole</p>	<p>VW75174:2018-10</p> <p>P 9.3 CAD determined</p>

<p><b>LV214 – TG10</b>  <b>Contacts: conductor pull-out strength</b>  Conductor pull-out strength  (only in connection with crimp)</p> <p>Pull-out force from the IDC  (only in connection with IDC)</p>	<p>n.a.</p> <p><math>F_{\text{pull-out}} &gt; 50\text{N}</math> (AWG30 ribbon cable)</p>	<p>VW75174:2018-10</p> <p>P 10.1</p> <p>P 10.2</p>
<p><b>LV214 – TG11</b>  <b>Contacts: insertion and extraction forces, number of mating cycles</b>  Insertion and removal force</p> <p>Number of mating cycles</p>	<p><math>F_{\text{insert/extract}} &lt; 25\%</math> Change of insertion / extraction force before and after load</p> <p>AU: 100 mating cycles</p>	<p>VW75174:2018-10</p> <p>P 11.1</p> <p>L11.1</p>
<p><b>DIN EN 60603-2 – Test AP - AP1</b>  <b>Gauge retention force</b></p>	<p><math>F_{\text{contact retention}} \geq 0,1\text{N}</math> (per contact)</p>	<p>DIN EN 60512-16-5</p>
<p><b>LV214 – TG17 (12 - 68-pole)</b>  <b>Dynamic load</b>  Volume resistance</p> <p>Volume resistance – continuous monitoring during mechanical loads L17.1 &amp; L17.2</p> <p>Dynamic load, sinusoidal</p> <p>Dynamic load, broadband noise</p> <p>Shock durability testing</p>	<p><math>R_{\text{before/after test}} \leq 50\text{ m}\Omega</math></p> <p>No current interruption (<math>&gt; 1\ \mu\text{s}</math> / <math>&gt;7\ \Omega</math>)</p>	<p>VW75174:2018-10</p> <p>P 0.2 / DIN EN 60512-2-1  After deduction of the cable resistance, the final contact resistances <math>P0.2 \leq 50\text{ m}\Omega</math></p> <p>P 14.0 Test is performed according to Severity level 2 (body – sealed)</p> <p>L 17.1 / DIN EN 600068-2-6  No sine wave load at S2</p> <p>L 17.2 / DIN EN 60068-2-64  <math>a_{\text{RMS}} 27.8\text{m/s}^2</math>; <math>t = 20\text{h}</math> per axis</p> <p>L 17.3 / DIN EN 60068-2-27  <math>a = 30\text{g}</math>; <math>t = 6\text{ms}</math>; shocks 6000</p>

<p><b>LV214 – TG17 (80-pole)</b></p> <p><b>Dynamic load</b></p> <p>Volume resistance</p> <p>Volume resistance – continuous monitoring during mechanical loads L17.1 &amp; L17.2</p>	<p><math>R_{\text{before/after test}} \leq 50 \text{ m}\Omega</math></p> <p>Outmost contacts show a slightly increased contact resistance, result is below the limit of <math>\leq 50 \text{ m}\Omega</math>,</p> <p><b>Deviate from that applies:</b> <b>Contact b<sub>1</sub> <math>R_{\text{after test}} &lt; 7\Omega</math></b></p> <p>No current interruption (<math>&gt; 1 \mu\text{s}</math> / <math>&gt; 7 \Omega</math>)</p> 	<p>VW75174:2018-10</p> <p>P 0.2 / DIN EN 60512-2-1</p> <p>After deduction of the cable resistance, the final contact resistances <math>P0.2 \leq 72 \text{ m}\Omega</math></p> <p>P 14.0</p> <p>Test is performed according to Severity level 2 (body – sealed)</p>
<p><b>DIN EN 60603-2 – Test Batch AP</b></p> <p>Gauge retention force</p> <p>Total insertion and withdrawal force</p> <p>Solderability</p> <p>Voltage proof</p> <p>Vibration sinusoidal Monitoring contact break</p> <p>Shock Monitoring contact break</p> <p>Rapid change of temperature</p> <p>Insulation resistance</p> <p>Voltage proof</p>	<p><math>F_{\text{contact retention}} \geq 0,1\text{N}</math> (per contact)</p> <p><math>F_{\text{I\&amp;W}} \leq 26\text{N}</math> (50-pole) <math>F_{\text{I\&amp;W}} \leq 40\text{N}</math> (80-pole)</p> <p>Not applicable</p> <p><math>U_{\text{test}} = 500V_{\text{eff}}</math> (contact/contact)</p> <p>Contact break <math>\leq 1 \mu\text{s}</math></p> <p>Contact break <math>\leq 1 \mu\text{s}</math></p> <p>Carry out</p> <p><math>R \geq 10^{10} \Omega</math></p> <p><math>U_{\text{test}} = 500V_{\text{eff}}</math> (contact/contact)</p>	<p>AP1 / DIN EN 60512-16-5</p> <p>AP2 / DIN EN 60512-13-2 MIL STD-1344 A 2013.1</p> <p>AP3 / DIN EN 60512-12-1</p> <p>AP4 / DIN EN 60512-4-1 MIL STD-1344 A 3001.1</p> <p>AP6 / DIN EN 60512-6-3 MIL STD-1344 A 3004.1 a = 1,5mm or 20g f = 10 – 2000Hz t = 7,5h No of cycles = 10</p> <p>AP7 / DIN EN 60512-6-3 MIL STD-1344 A 1003.1 a = 490m/s (50g) half sine: 3,43m/s<sup>2</sup> t = 11ms No of cycles: 10 shocks/axis</p> <p>AP9 / DIN EN 60512-11-4 MIL STD-1344 A 1003.1 T = -55°C to +125°C t = 30 min No of cycles = 5</p> <p>AP10 / DIN EN 60512-3-1 MIL STD-1344 A 3003.1</p> <p>AP11 / DIN EN 60512-4-1 MIL STD-1344 A 3001.1</p>

Visual examination	No faults	AP12 / DIN EN 60512-1-1
Climatic sequence	Carry out	AP13 / DIN EN 60512-11-1
Dry heat		13.1 / DIN EN 60512-11-9 T = +125°C t = 16h
Damp heat, cyclical		13.2 / DIN EN 60512-11-13 variant 1
Cycle 1		T = 55°C
Cold		13.3 / DIN EN 60512-11-10 T = -55°C
Damp heat, cyclical		13.5 / DIN EN 60512-11-1
Cycle 2 - 6		T = 55°C
Insulation resistance	$R \geq 10^{10} \Omega$	AP14 / DIN EN 60512-3-1 MIL STD-1344 A 3003.1
Contact resistance	$R \leq 25m\Omega$	AP15 / DIN EN 60512-2-1 MIL STD-1344 A 3002.1
Voltage proof	$U_{test} = 500V_{eff}$ (contact/contact)	AP16 / DIN EN 60512-4-1 MIL STD-1344 A 3001.1
Total insertion and withdrawal force	$F_{I\&W} \leq 26N$ (50-pole) $F_{I\&W} \leq 40N$ (80-pole)	AP17 / DIN EN 60512-13-2 MIL STD-1344 A 2013.1
Visual examination	No faults	AP18 / DIN EN 60512-1-1

ENVIRONMENTAL		
<b>LV214 TG5</b>		
Mechanical and thermal relaxation behavior		VW75174:2010-04
Contact normal force		
Unused	$\geq 0,1 N$	E5.2 (retention force with gauge)
After B5.3 aging in dry heat	$\geq 0,1 N$	E5.2 (retention force with gauge) B5.3 / DIN EN 60068-2-2 / Test B 1000 h @ 125°C
<b>LV214 – TG15</b>		
<b>Electrical stress test</b>		
Volume resistance	$R_{before/after\ test} \leq 50\ m\Omega$ (AWG30)	VW75174:2018-10 P 0.2 / DIN EN 60512-2-1
Derating (before/after test)	$I_{nominal\ change} < 20\%$	P12.2 / DIN EN 60512-5-2 with housing $I_{nom} = 2,98A / 2,8A$ (20-pole) $3,0A / 3,0A$ (40-pole) $3,3A / 3,3A$ (80-pole)
Temperature/ current cycle endurance test:		B15.2 / 60 cycl. -40°C/T <sub>o</sub> =125°C $I_{test} = 3,7A$ (20-pole); $3,0A$ (40-pole) $3,8A$ (80-pole)

<p>Humidity heat, cyclic:</p> <p>Temperature/ current cycle endurance test:</p>		<p>B15.3 / DIN EN 60068-2-30 21x1day @ 25°C/55°C @ 95%RH</p> <p>B15.2</p>
<p><b>LV214 – TG18A</b></p> <p><b>Coastal climate load</b></p> <p>Volume resistance</p> <p>Salt spray, cyclic</p>	<p><math>R_{\text{before/after test}} \leq 50 \text{ m}\Omega</math></p>	<p>VW75174:2018-10</p> <p>P 0.2 / DIN EN 60512-2-1</p> <p>B 18.2 / DIN EN 60068-2-52 Severity 3</p>
<p><b>LV214 – PG19</b></p> <p><b>Environmental simulation</b></p> <p>Volume resistance</p> <p>Temperature shock</p> <p>Temperature change</p> <p>Aging in dry heat</p> <p>Industrial climate (multi-component climate)</p>	<p><b>Connector 12-pole to 40-pole</b></p> <p><math>R_{\text{before/after test}} \leq 50 \text{ m}\Omega</math></p> <p><b>Connector 50-pole to 80-pole</b></p> <p><math>R_{\text{before/after test}} \leq 50 \text{ m}\Omega</math></p> <p><b>Deviate from that applies:</b> Contact resistance of contact <math>b_1, a_1</math> &amp; <math>b_n, a_n</math> increases after temperature load. *Contact <math>b_1, a_1, b_n, a_n</math> <math>R_{\text{after test}} &lt; 7\Omega</math></p>   <p>* n-contact for: 50-pin: <math>a_n = a_{25}</math> ; <math>b_n = b_{25}</math> 68-pin: <math>a_n = a_{34}</math> ; <math>b_n = b_{34}</math> 80-pin: <math>a_n = a_{40}</math> ; <math>b_n = b_{40}</math></p>	<p>VW75174:2018-10</p> <p>P 0.2 / DIN EN 60512-2-1</p> <p>L 19.1 / DIN EN 60068-2-14, Test Na</p> <p>Duration: 144 cycles (72h) Temperature: -40 °C/130°C (a 15min; <math>\updownarrow</math> 10s)</p> <p>L 19.2 / DIN EN 60068-2-14, Test Nb</p> <p>Duration: 20 cycles Temperature: -40 °C/130°C (a 3h; <math>\updownarrow</math> 2h)</p> <p>L 19.3 / DIN EN 60068-2-2, Test B</p> <p>Duration: 120 h Temperature: 130°C</p> <p>L 19.4 / DIN EN 60512-11-7</p> <p>Duration: 21d SO<sub>2</sub>, 0,2 ppm H<sub>2</sub>S, 0,01 ppm NO<sub>2</sub>, 0,2 ppm Cl<sub>2</sub> 0,01 ppm Temperature: 25°C Humidity: 75% RH Flow rate: 1 m<sup>3</sup>/h</p>

<p>Damp heat, cyclic</p> <p>Dynamic load, Broadband noise</p> <p>Mechanical shock testing (individual shocks)</p>		<p>L 19.5 / DIN EN 60068-2-30, variant 2 Duration: 10 cycles of 24h each <math>T_u = 25\text{ }^\circ\text{C}</math>, <math>T_o = 55\text{ }^\circ\text{C}</math>, RH 95%</p> <p>L 19.6 / DIN EN 60068-2-64 <math>a_{\text{RMS}} 13.9\text{m/s}^2</math>; <math>t = 6\text{h}</math> per axis</p> <p>L 19.7 / DIN EN 60068-2-27 <math>a = 30\text{g}</math>; <math>t = 6\text{ms}</math>; shocks 50 per axis</p>
<p><b>LV214 – PG20</b> <b>Climate load of the housing</b></p> <p>Aging in dry heat</p> <p>Aging in damp heat</p> <p>Low-temperature aging</p> <p>Extracting and inserting at <math>-20^\circ\text{C}</math> Aging in dry heat</p> <p>Drop test in the unplugged state</p>	<p>Conformity to TestGroup specific functional requirements.</p>	<p>VW75174:2018-10</p> <p>L 20.1 / DIN EN 60068-2-2, Test B Duration: 120 h Temperature: <math>125^\circ\text{C}</math></p> <p>L 20.2 / DIN EN 60068-2-30 Duration: 10 days Temperature: <math>40^\circ\text{C}</math> Relative humidity: 95 %</p> <p>L 20.3 / DIN EN 60068-2-1 Duration: 48 h Temperature: <math>-40^\circ\text{C}</math></p> <p>L 20.4</p> <p>L 20.5 / DIN EN 60068-2-2, Test B Duration: 48 h Temperature: <math>80^\circ\text{C}</math></p> <p>L 6.1 / VW75174:2018-10</p>
<p><b>LV214 – TG21</b> <b>Long-term temperature aging</b></p> <p>Volume resistance</p> <p>Long-term aging in dry heat</p> <p>B 6.1 Drop test</p>	<p>Conformity to TestGroup specific functional requirements <math>R_{\text{before/after test}} \leq 50\text{ m}\Omega</math></p>	<p>VW75174:2018-10</p> <p>P 0.2 / DIN EN 60512-2-1</p> <p>L 21.1 / DIN EN 60068-2-2, Test B Duration: 1000 h Temperature: <math>130^\circ\text{C}</math> Subsequent aging: 48h at RT</p> <p>VW75174:2018-10</p>

<p><b>LV214 – TG22A</b></p> <p><b>Chemical resistance</b></p> <p>Insulation resistance</p> <p>Resistance to agents</p>	<p>Conformity to TestGroup specific material &amp; functional requirements</p> <p><math>R_{ins}</math> before/after test &gt; 100M<math>\Omega</math> at U=500V, t=60s</p>	<p>VW75174:2018-10</p> <p>P 0.3 / DIN EN 60512-3-1</p> <p>L 22.1A / VW75174:2018-10 Appendix E.1 media list Duration: 48h</p> <p>Temperature: media specific</p>
<p><b>DIN EN 60603-2 – Test Batch BP</b></p> <p>Gauge retention force</p> <p>Mechanical operation 1st half</p> <p>Industrial atmosphere</p> <p>Contact resistance</p> <p>Mechanical operation 2nd half</p> <p>Insulation resistance</p> <p>Voltage proof</p> <p>Gauge retention force</p> <p>Visual examination</p>	<p><math>F_{contact\ retention} \geq 0,1N</math> (per contact)</p> <p>Carry out</p> <p>Carry out</p> <p><math>R \leq 25m\Omega</math></p> <p>Carry out</p> <p><math>R \geq 10^{10} \Omega</math></p> <p><math>U_{test} = 500V_{eff}</math> (contact/contact)</p> <p><math>F_{contact\ retention} \geq 0,1N</math> (per contact)</p> <p>No faults</p>	<p>BP1 / DIN EN 60512-16-5</p> <p>BP2 / DIN EN 60512-9-1 MIL STD-1344 A 2016 V = <math>\leq 10mm/s</math> Rest period: <math>\leq 30s</math> (not inserted) No of cycles: 250</p> <p>BP3.2 / DIN EN 60512-11-7 Test climate: 25°C/ 75% RH Gas concentration: mixed flowing gas 0,5ppm SO<sub>2</sub> + 0,1ppm H<sub>2</sub>S t = 10 days one half of specimen inserted; the other half not inserted.</p> <p>BP4 / DIN EN 60512-2-1 MIL STD-1344 A 3002.1</p> <p>BP5 / DIN EN 60512-9-1 MIL STD-1344 A 2016 V = <math>\leq 10mm/s</math> Rest period: <math>\leq 30s</math> (not inserted) No of cycles: 250</p> <p>BP6 / DIN EN 60512-3-1 MIL STD-1344 A 3003.1</p> <p>BP7 / DIN EN 60512-4-1 MIL STD-1344 A 3001.1</p> <p>BP9 / DIN EN 60512-16-5</p> <p>BP10 / DIN EN 60512-1-1</p>
<p><b>DIN EN 60603-2 – Test Batch CP</b></p> <p>Damp heat, steady</p>		<p>CP1 / DIN EN 60512-11-3 MIL STD-1344 A 1002.1</p> <p>Polarization voltage: not applied Test climate: 40°C/ 93% RH t = 56 days</p>



Insulation resistance	$R \geq 10^{10} \Omega$	CP2 / DIN EN 60512-3-1 MIL STD-1344 A 3003.1
Contact resistance	$R \leq 25\text{m}\Omega$	CP3 / DIN EN 60512-2-1 MIL STD-1344 A 3002.1
Voltage proof	$U_{\text{test}} = 500V_{\text{eff}}$ (contact/contact)	CP4 / DIN EN 60512-4-1 MIL STD-1344 A 3001.1
Visual examination	No faults	CP5 / DIN EN 60512-1-1

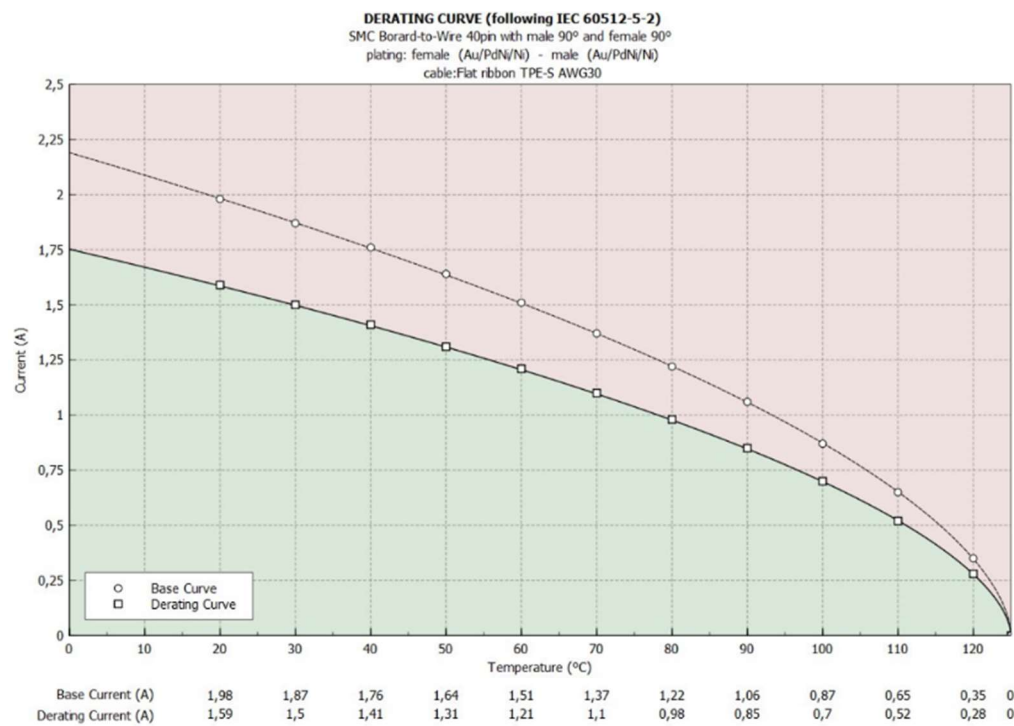
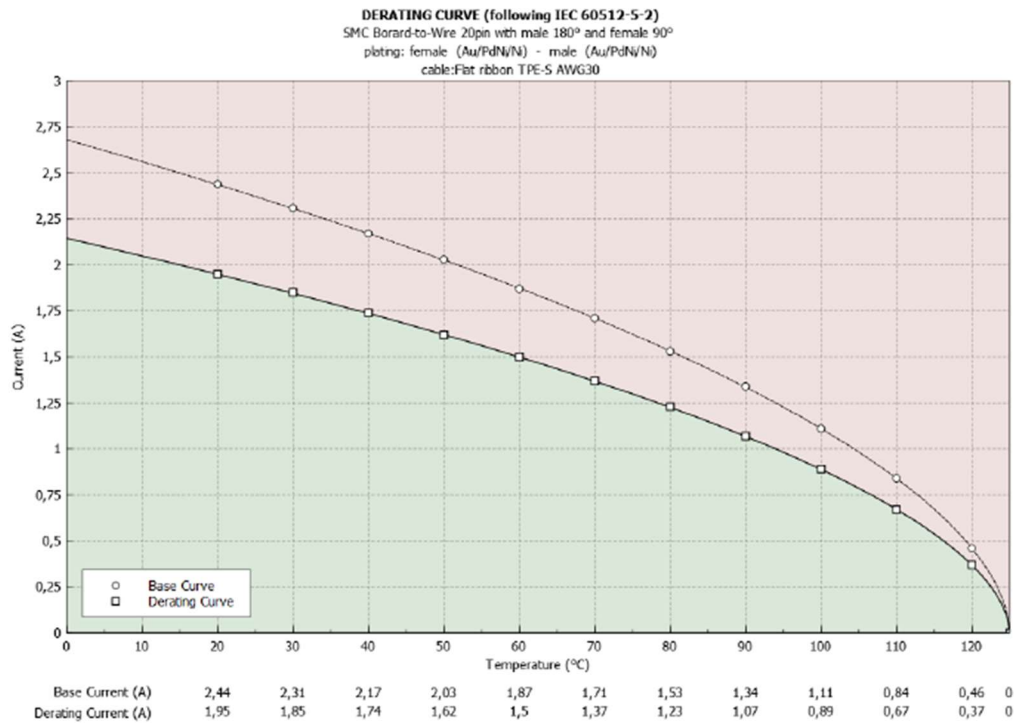
### 3.6. Product Qualification and Requalification Test Sequences

For the product qualification all test groups and sequences are carried out in accordance with DIN EN 60603-2 and LV214 as per Chapter 3.5.

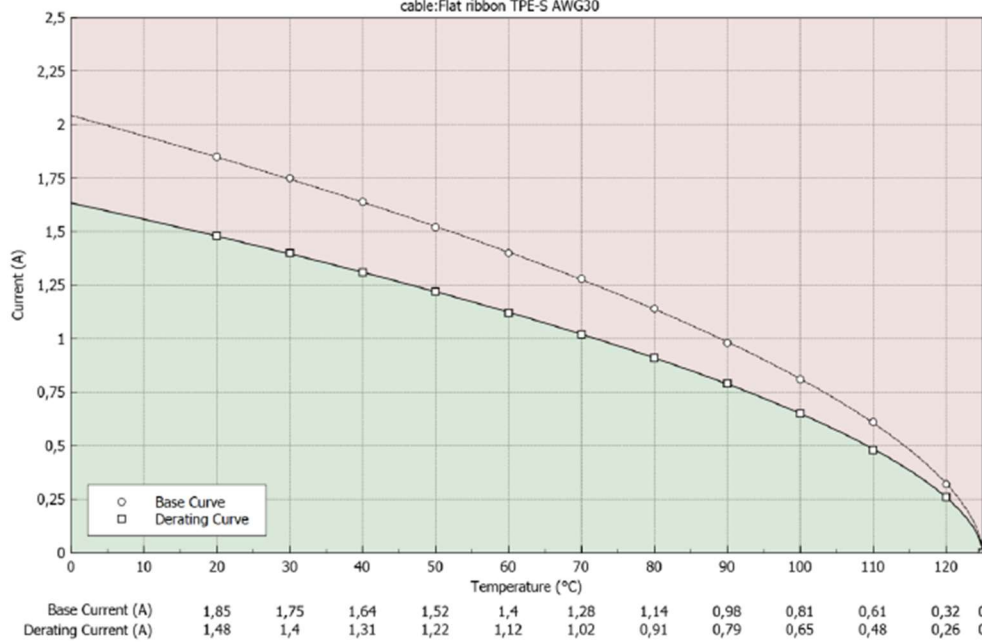
A product requalification is performed annually with at least one selected connector type of a product family. Every requalification includes tests to ensure the functionality and dimensional accuracy of the products. Unless otherwise specified by TE, a requalification test will be carried out at the same revision level as specified in Chapter 3.5

## 4. APPENDIX

### 4.1. Derating - Number of Poles Specific



**DERATING CURVE (following IEC 60512-5-2)**  
 SMC Board-to-Wire 80pin with male 90° and female 90°  
 plating: female (Au/PdNi/Ni) - male (Au/PdNi/Ni)  
 cable: Flat ribbon TPE-S AWG30



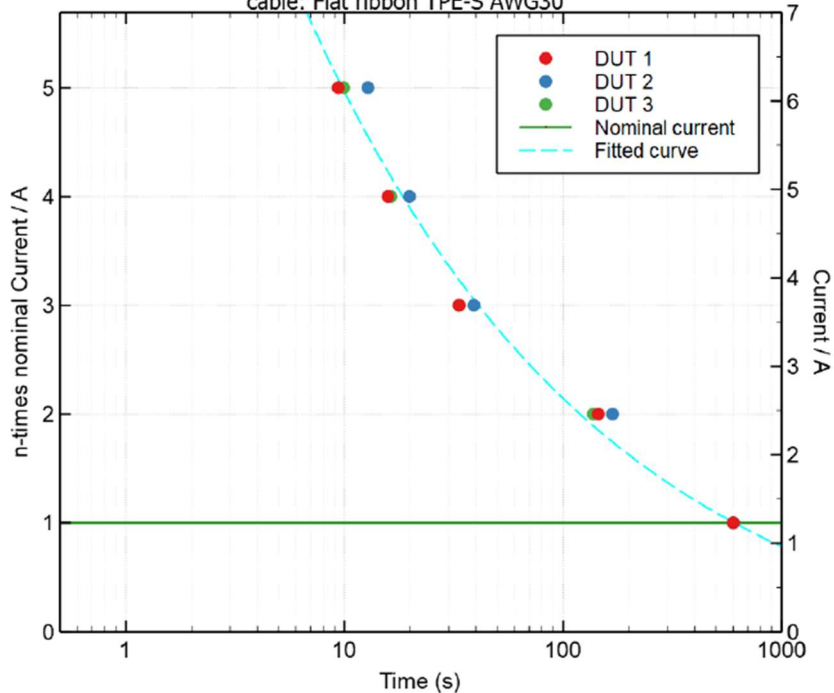
4.2. Resistance Limits – LV214 Appendix Table D.1

Conductor cross section in mm <sup>2</sup> /contact size in mm	Group 1						Group 2					Group 3	
	0.13	0.22	0.35	0.5	0.75	1	1.5	2.5	4	6	10	16	> 16
0.5	50	40	30	-	-	-	-	-	-	-	-	-	-
0.63	30	30	15	15	15	-	-	-	-	-	-	-	-
1.2	20	20	15	15	15	15	10	-	-	-	-	-	-
1.5	15	15	15	15	15	15	10	10	-	-	-	-	-
2.8	15	15	15	15	15	10	10	10	5	-	-	-	-
4.8 – 6.3	10	10	10	8	8	8	5	5	3	3	2	-	-
8	-	-	-	-	-	-	-	3	3	3	2	2	-
9.5 – 12	-	-	-	-	-	-	-	-	3	2	2	1	1

4.3. Thermal Time Constant – LV214 TG14

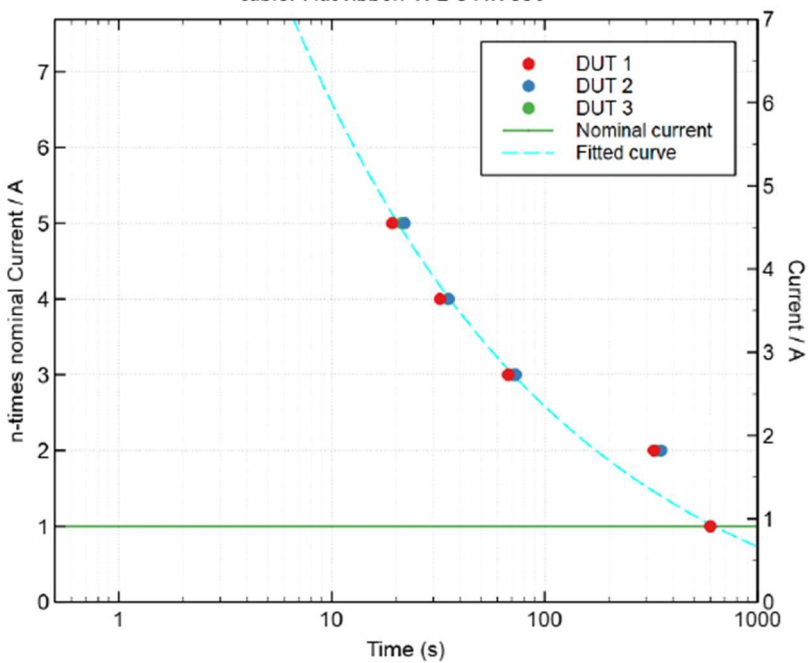
**TG14 Thermal time constant (following VW 75174 :2018-10)**

SMC Board-to-Wire 20pin with male 180° and female 90°  
 plating: male (Au / PdNi / Ni)  
 plating: female (Au / PdNi / Ni)  
 cable: Flat ribbon TPE-S AWG30



**TG14 Thermal time constant (following VW 75174 :2018-10)**

SMC Board-to-Wire 80pin with male 90° and female 90°  
 plating: male (Au / PdNi / Ni)  
 plating: female (Au / PdNi / Ni)  
 cable: Flat ribbon TPE-S AWG30



- 4.4. Dynamic Load – LV214 TG17
- 4.5. Shaker Table Mounting – LV214 Appendix B

See figure B.1 and figure B.2

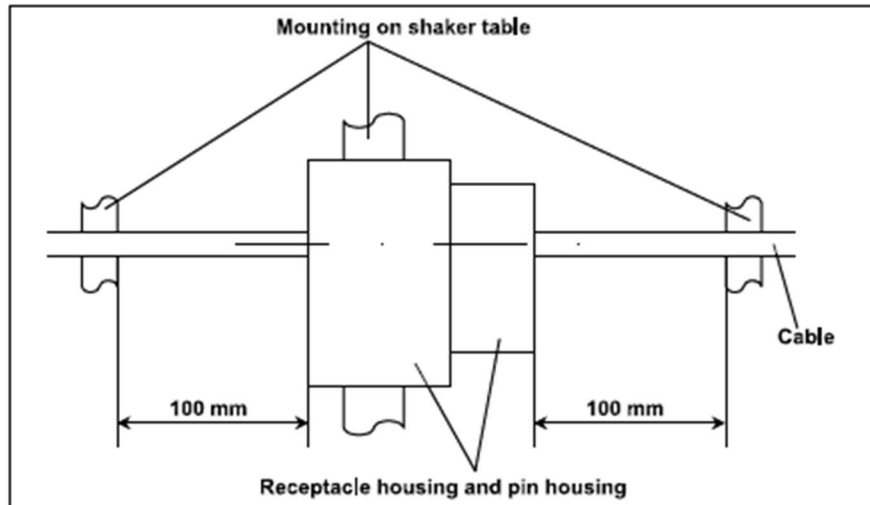


Figure B.1 – Mounting on shaker table, coupling

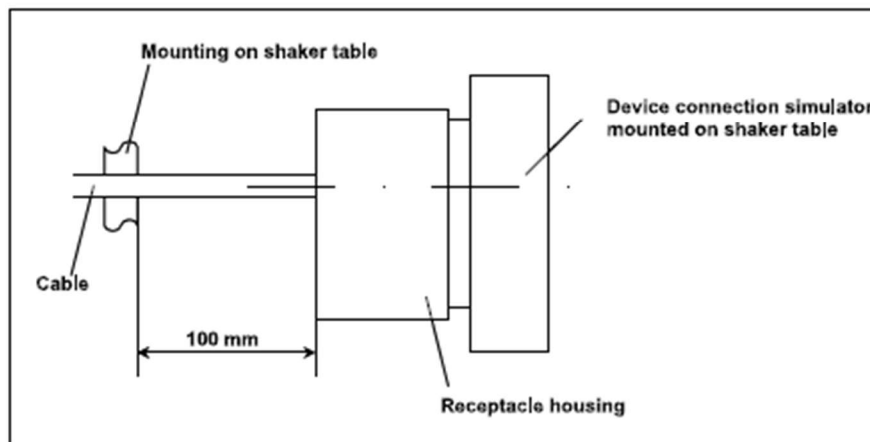


Figure B.2 – Mounting on shaker table, device connection

**5. REVISION HISTORY TABLE**

<b>REV</b>	<b>Revision record</b>	<b>Drawn</b>	<b>Checked</b>	<b>Approved</b>	<b>Date</b>
<b>A</b>	Published to PDM Link & DSD	T. Lengenfelder	T. Oberschelp	S. Kaminski	23 Apr 2024